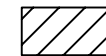


P.C.B LAYOUT DIM.



PATTERN



LAND FOR SOLDER PASTE

NO	QTY	PART NO	DESCROPTION	MATERIAL	FINISH	DATE	TOLERANCE	DESCRIPTION		
1	1		BODY	BRASS	GOLD PLATED	2011/07/24	DIM : .X \pm 0.25MM .XX \pm 0.12MM	MMCX ST JACK FOR P.C.B		
2	1		INSULATOR	TEFLON	NONE	UNIT		MM	EDGE MOUNT	
3	1		CONTACT	BERYLLIUM COPPER	GOLD PLATED	DRAWING	APPROVE BY	PART NO :		
						Leon	John	1-3008-091R000		
						 連科電子股份有限公司 Connectec Electronics Co., Ltd.				